Quantic Eulex®

Revolutionizing High-Frequency Applications: 3-Terminal XG3 Gap Capacitor

Colin McClennan, VP/GM Quantic Electronics | Capacitors

Alex Moalemi, Founder Quantic Eulex



CMSE25

Speakers





- Capacitor manufacturing leader with 20+ years of experience in engineering and processes.
- As Vice President and General Manager at Quantic Electronics, he drives strategic initiatives and oversees operations, fostering innovation and organizational growth of the Capacitor Division.
- Board Member since 2007, Southeastern New England Defense Industry Alliance (SENEDIA)

Colin McClennan
VP/GM, Quantic Electronics | Capacitors
Quantic



- Electrical engineer with over 25 years of experience in the passive components industry.
- Electrical component innovator, having been awarded 3 patents, with additional patents pending.
- Developed passive components for companies such as Presidio, Novacap, Powergenix, and Wright Capacitors, prior to joining Quantic Eulex.

Alex Moalemi
Founder
Quantic Eulex

About Quantic™ Eulex



- Quantic™ Eulex, formerly known as Eulex Components, was founded in 2019 by Alex Moalemi.
- Quantic[™] Eulex is located in Monterey Park, California.
- The primary objective in forming Quantic™ Eulex was to work on a single layer capacitor (SLC) replacement technology, and that was achieved in 2021 when the company's US Patent was granted.
- Quantic™ Eulex develops innovative ceramic components for the most demanding high-frequency microwave, millimeter-wave, and 5G applications. Their solutions deliver design advantages through small-footprint, low-profile packaging, and a wide voltage range, fully tested up to 70Ghz with a roadmap planned from 6.5 to 100 GHz. The reliability of Quantic™ Eulex capacitors is well-established, at temperatures ranging from -55° to 125°C.

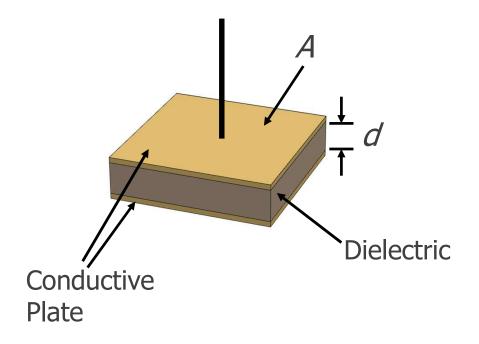
Meeting Performance Needs in High Frequency Applications Quantic Eulex®

The industry's demand for the Eulex 3-Terminal capacitor stems from the need to overcome the limitations of conventional single-layer wire-bondable ceramic capacitors, enabling effective performance in high-frequency applications, including 5G, microwave, and millimeter-wave systems.

Advantages of the Single Layer Capacity (SLC)



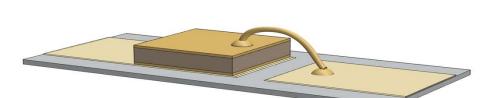
- Capacitor in Simplest Form
- Closest to an "Ideal Capacitor"
- Ceramic Dielectric
- Monolithic Device
- Low Resistivity Electrodes
- Low Equivalent Series Resistivity (ESR)
- Low Dissipative Loss
- High Self Resonant Frequency

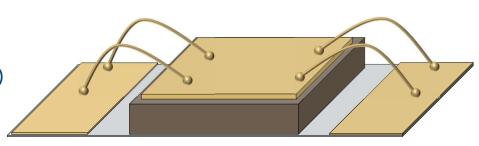


Limitations of the SLC in Demanding, High Frequency Applications

Quantic Eulex

- Capacitance Limitations
- Highly dependent on dielectric constant
- Many dielectrics
- Performance trade-offs as material ε increases
- Wire-Bond
- Expensive equipment
- Manufacturing difficulties
- Reliability
- Performance of circuit (especially at higher frequencies)





SLC Typical Wire-Bond Attachment

1st Generation: Eulex 2-Terminal Gap Capacitor

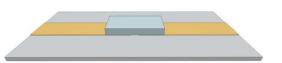


Patented Technology Mitigates Many Limitations of the SLC and Provides 10x Capacitance

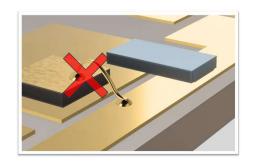
Advantages

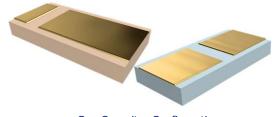
- > Up to 20x capacitance
- > Fewer Dielectrics
- > True Single Layer (no vias)
- > High Reliability

- > No Wire-Bond
- > Simpler Part Selection
- > Ultra-High Q Dielectrics
- > Range of Voltages



Gap capacitor mounted face-down on strip-line





Gap Capacitor Configurations

	Maximum Capacitance / pF															
	100 Volt				50 Volt				16 Volt			6.3 Volt				
	Р	NP 0	X7 R	Ma x	Р	NP 0	X7 R	Ma x	Р	NP 0	X7 R	Ma x	Р	NP 0	X7 R	Ma x
Company A	X	1.0	82	120	X	X	X	X	Χ	X	X	X	X	X	X	X
Company B	X	X	X	X	X	X	X	*1400	X	X	X	X	X	X	X	X
Company C	X	X	X	X	0.2	1.5	68	*250	X	X	X	X	X	X	X	X
Company D	0.2	2	68	*820	0.3	2.7	68	*1200	Χ	X	X	X	X	X	X	X
Eulex	3.3	47	1400	5800	3.9	56	1700	6800	5.6	80	2400	10000	8.7	120	3600	15000

Competitor Comparison (Based on 0804 size device)

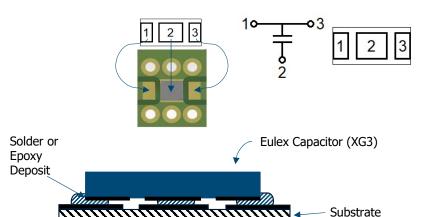
^{*} Uses GBBL dielectric

Filters & Decoupling Capacitors 3-Terminal (XG3) Capacitor Quantic Eulex®



Features:

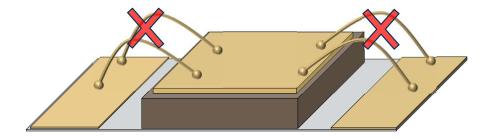
- Single-layer Design: Balanced shunt capacitors for effective EMI filtering and noise attenuation.
- Filtering: Offers exceptional rejection for both single-ended and differential configurations (tested to 70 GHz)
- Low Inductance: Achieved the lowest ESL and maintained temperature stability of less than 0.2 dB, enhancing high-frequency performance and attaining extremely low mounting inductance of the 3terminal gap capacitor, all within a surface-mountable package..
- Component Reduction: Substitutes SLC/X2Y components with a single EMI filter (XG3).
- Applications: Ideal for amplifier decoupling, high-speed data filtering, and much more.....



3-pad terminal Gap capacitor mounted face-down on GCPW (coplanar waveguide w/GND)

Applications:

- **Amplifier Filter and Decoupling**
- High-Speed Data Filtering
- EMC I/O Filtering
- FPGA / ASIC/μ-P Decoupling
- DDR Memory Decoupling



2nd Generation: Eulex 3-Terminal XG3 Capacitor



Building upon the success of the 2-Terminal design, the 3-Terminal Eulex Gap Capacitor represents a further refinement of the technology, pushing the boundaries of performance even further.

Advantages

Negligible Mounting Inductance

Highest Capacitance

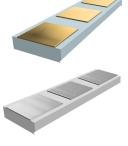
Fewer Dielectrics

True-Single Layer (no vias)

High Reliability

- ■No Wire-Bond
- ■Simpler Part Selection
- ■Ultra-High Q Dielectrics

Range of Voltages



3-pad Terminal Gap Capacitor Configurations

Solder or Epoxy
Deposit
Substrate

1 2 3

3-pad terminal Gap capacitor mounted face-down on GCPW (coplanar waveguide w/GND)

6.3V	1809	1707	1507	0602	0502	0301	
	Cap (pF)						
Р	100	68	39	7.5	5.6	1.2	
Q	220	150	82	15	12	3.0	
N	700	500	270	56	40	10	
С	3200	2200	1200	240	180	40	
Х	22000	15000	8200	1600	1200	290	
Y	100000	68000	37000	7500	5600	1300	

Available In 6.3V to 100V

100V	1809	1707	1507	0602	0502	0301	
	Cap (pF)						
Р	40	27	15	3.0	2.2	0.6	
Q	95	65	35	7.0	5.0	1.2	
N	300	200	120	22	17	4.0	
С	1300	900	500	100	75	18	
Х	9000	6400	3500	700	530	120	
Υ	43000	29000	15000	3000	2200	560	

Performance Data

Data Courtesy of



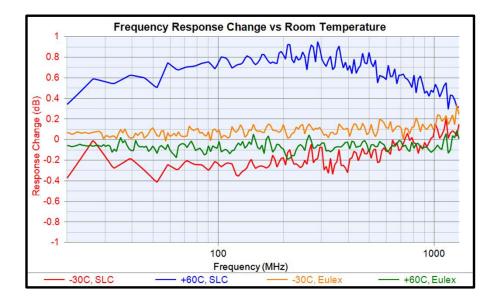




Our circuit was in need of a capacitor with 2 major requirements:

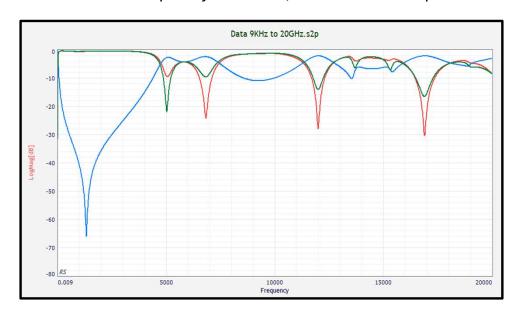
Exceptional high-frequency response that was typically only available with a single-layer capacitor (SCL)Relatively high capacitance value (270pF) with NPO-type stability

Grounded coplanar waveguide (SLC vs 3-pad Terminal)

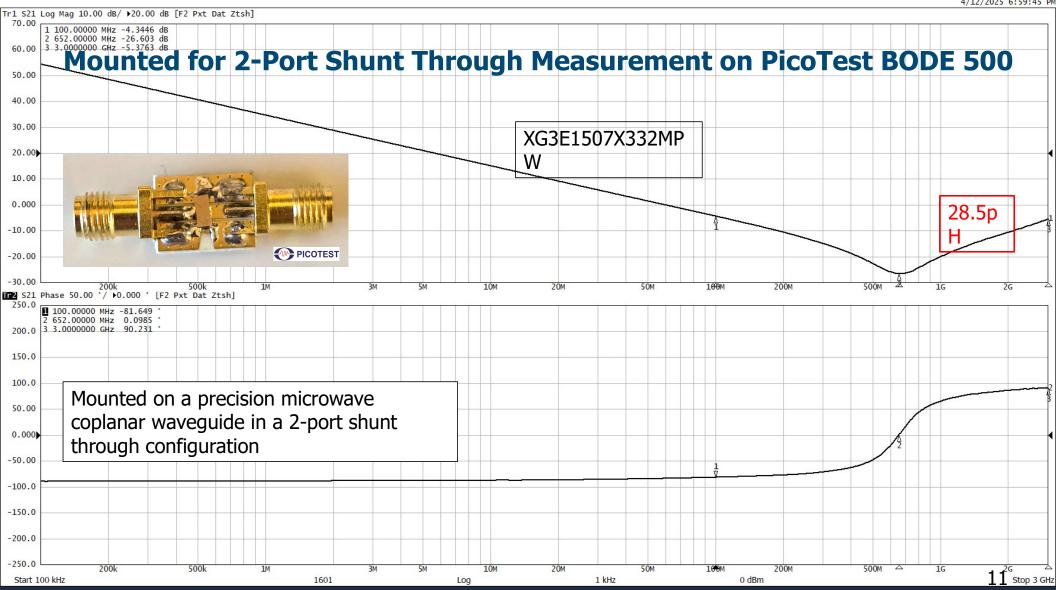


XG3A150N271KPW

Resonant Frequency is 1.6GHz, and the ESL of 28pH

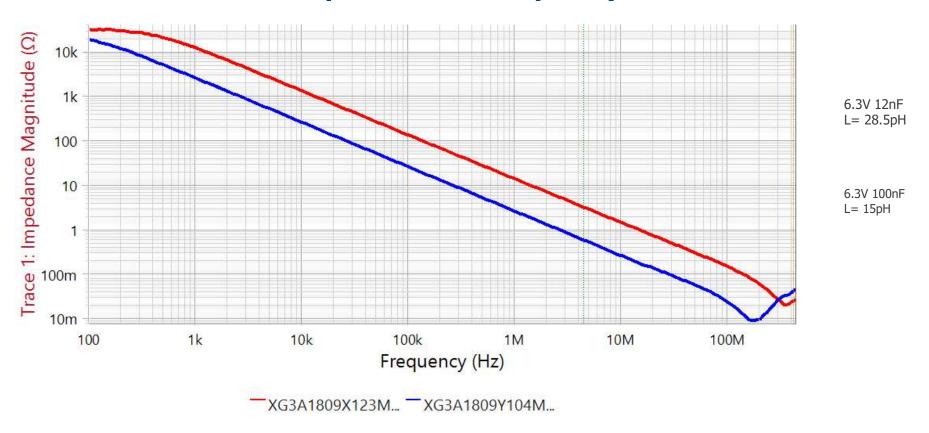


"The Eulex part is our answer to a 5-year search for a better capacitor that has Class I stability, high capacitance, and great frequency response, allowing our product to better meet our specifications over time and temperature" – Martin Dummermuth, Chief Technologist





Impedance Vs Frequency



Summary



The novel structure of our Eulex capacitor offers ultra- high SRF, ultra-low inductance, the highest capacitance density in a true single layer device all wrapped up in a high reliability surface mount package. The compact form factor allows these parts to be very close to the IC and are also suitable for embedded designs.

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Thank You!

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